





## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Appln. Of:

Hiroaki YOKOYAMA

Serial No.:

08/992,767

Filed:

December 17, 1997

For: CONTACT STRUCTURE IN SEMICONDUCTOR INTEGRATED...

Group:

2814

Examiner:

D. Wille

DOCKET:

NEC 19654

The Honorable Commissioner of Patents & Trademarks Washington, D.C. 20231

## **AMENDMENT B UNDER RULE 116**

Dear Sir:

This Amendment is being filed in response to the Official Action mailed May 25, 1999. Please amend the application as follows:

## **IN THE SPECIFICATION:**

Page 5, line 16, after "included" insert --in--.

## **IN THE CLAIMS:**

Please amend claim 1 as follows:

1. (Twice Amended) A semiconductor device including both a large-diameter contact hole and a small-diameter contact hole formed to penetrate through an insulator film formed on a conductive portion to reach said conductive portion, said small-

> RECEIVED SEP 0 3 1999

**TECHNOLOGY CENTER 2800** 

HAYES, SOLOWAY, HENNESSEY, GROSSMAN & HAGE, P.C. 175 CANAL STREET MANCHESTER, NH 03101-2335 U.S.A.

603-668-1400